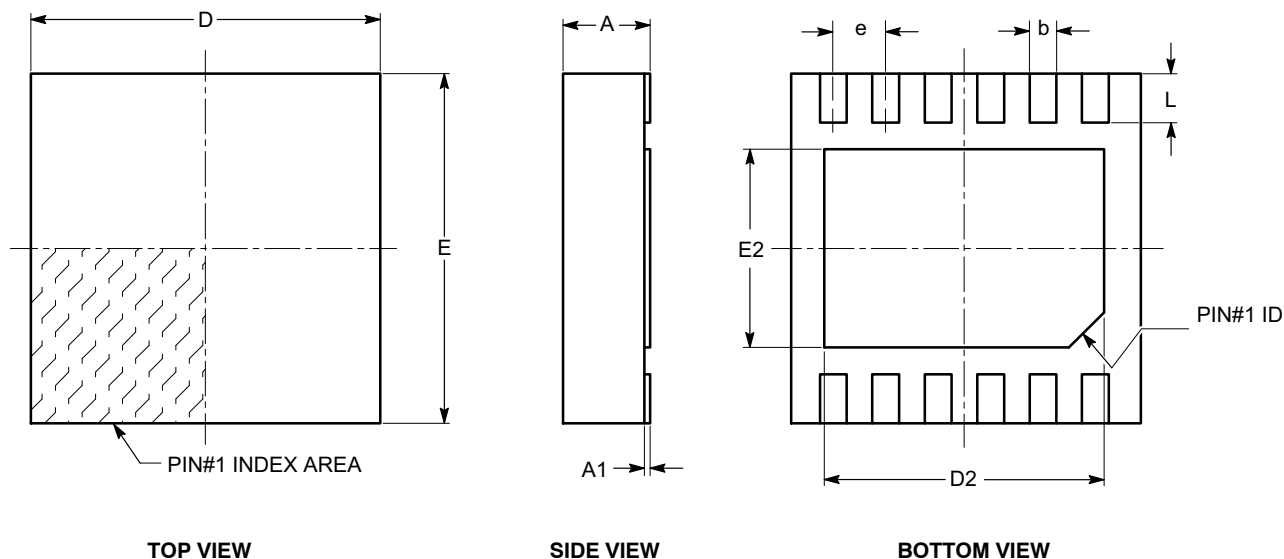


**TDFN12, 3x3**  
**CASE 511AN**  
**ISSUE A**

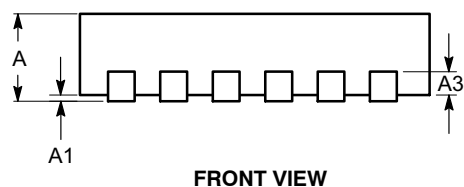
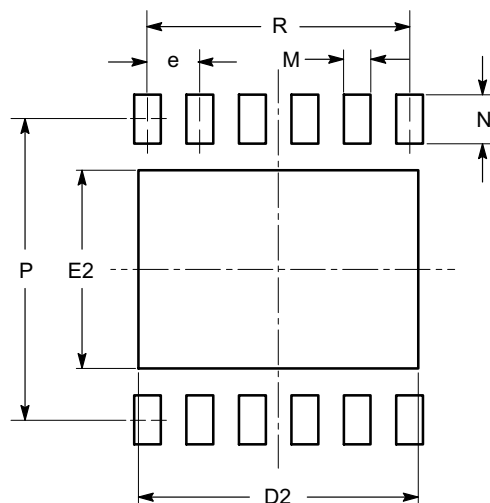
DATE 18 MAR 2009



SYMBOL	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A3	0.178	0.203	0.228
b	0.18	0.23	0.30
D	2.90	3.00	3.10
D2	2.30	2.40	2.50
E	2.90	3.00	3.10
E2	1.55	1.70	1.75
e	0.45 BSC		
L	0.30	0.40	0.50
M	0.25	0.30	0.35
N	0.60	0.70	0.80
P	2.70	3.00	3.10
R	2.25 TYP		

**Notes:**

- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MO-229.


**FRONT VIEW**
**RECOMMENDED LAND PATTERN**


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<b>DESCRIPTION:</b>	<b>TDFN12, 3X3</b>	<b>PAGE 1 OF 1</b>

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